



## 2SC407 thru 2SC412

### Use

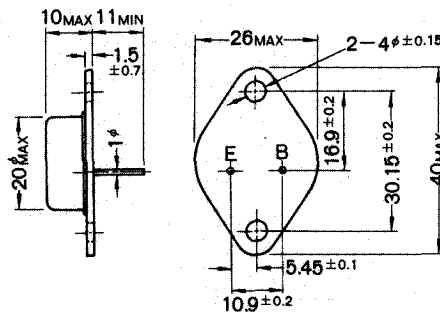
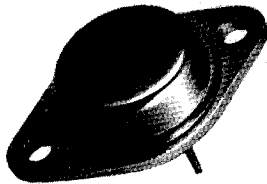
- For high-frequency power amplification
- For high-frequency power switching

### Construction

- NPN triple diffusion type

SHINDENGEN'S silicon power transistors are all outside comparison in performance and really epoch-making to realize that even one piece of element is powerful enough to treat several kW of large power in the area of high-frequency wave.

It is expected that silicon power transistors will play an important part for the electronic equipment developing to find further utility and advantage in the future.



### Dimensions

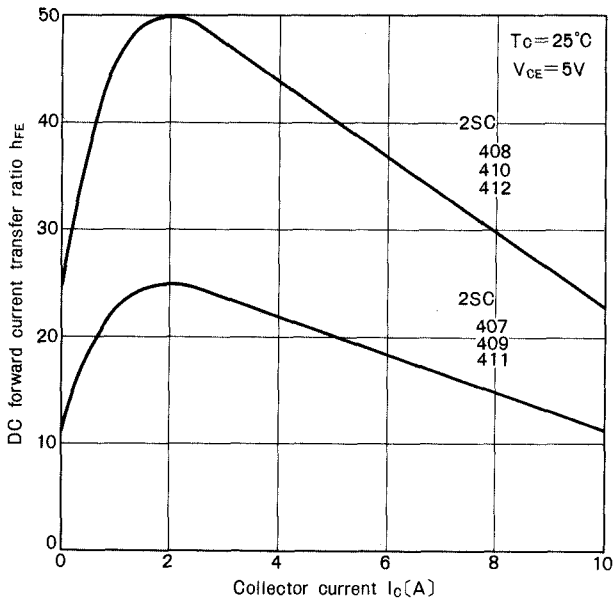
Unit : mm

### Ratings

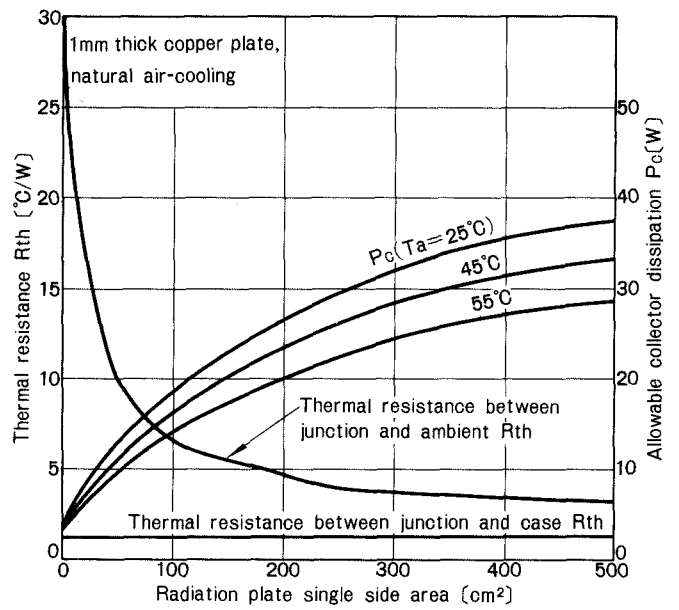
Item	Symbol	Unit	Type	Conditions							
				2SC 407	2SC 408	2SC 409	2SC 410	2SC 411	2SC 412		
Absolute maximum ratings	Storage temperature	Tstg	°C	-55 ~ +150							
	Junction temperature	Tj	°C	+150							
	Emitter-base voltage	V <sub>EB0</sub>	V	4							
	Collector-base voltage	V <sub>CB0</sub>	V	150	150	200	200	300	300		
	Collector-emitter voltage	V <sub>CE0</sub>	V	100	100	140	140	200	200		
	Collector current	I <sub>c</sub>	A	10							
	Base current	I <sub>b</sub>	A	3							
	Collector dissipation	P <sub>c</sub>	W	100							
Electrical characteristic	Emitter cutoff current	I <sub>EB0</sub>	mA	At rated voltage	MAX 25						
	Collector cutoff current	I <sub>CB0</sub>	mA	At rated voltage	MAX50	50	20	20	5	5	
	Collector cutoff current	I <sub>CE0</sub>	mA	At rated voltage	MAX50	50	30	30	10	10	
	DC forward current transfer ratio	h <sub>FE</sub>		V <sub>CE</sub> = 5V I <sub>c</sub> = 5A	MIN	10	20	10	20	10	20
					STD	20	40	20	40	20	40
					MAX	30		30		30	
	Collector-emitter saturation voltage	V <sub>CE(SAT)</sub>	V	I <sub>c</sub> = 5A I <sub>b</sub> = 2A	STD	0.4					
					MAX	1					
Base-emitter saturation voltage	V <sub>BE(SAT)</sub>	V	I <sub>c</sub> = 5A I <sub>b</sub> = 2A	STD	1.2						
				MAX	2						
Thermal resistance	R <sub>th</sub>	°C/W	Between junction and case	1.25							
High-frequency characteristic	Cutoff frequency	f <sub>ce</sub>	kHz	V <sub>CE</sub> = 10V, I <sub>c</sub> = 2A	STD	400					
	Collector output capacitance	C <sub>ob</sub>	PF	V <sub>CB</sub> = 20V, I <sub>c</sub> = 0 f = 1MHz	STD	300					
					MAX	500					
Pulse characteristic	Delay time	t <sub>d</sub>	μS	I <sub>c</sub> = 5A	MAX	0.2					
	Rise time	t <sub>r</sub>	μS	R <sub>L</sub> = 5Ω	MAX	1					
	Storage time	t <sub>s</sub>	μS	I <sub>b1</sub> = 1A	MAX	4					
	Fall time	t <sub>f</sub>	μS	I <sub>b2</sub> = -1A	MAX	1					

Note : Case temperature T<sub>c</sub> = 25°C

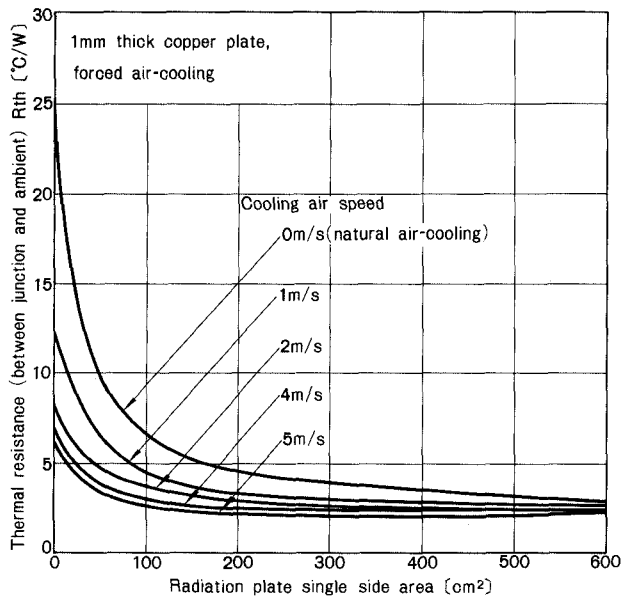
**Collector current — DC forward current transfer ratio**



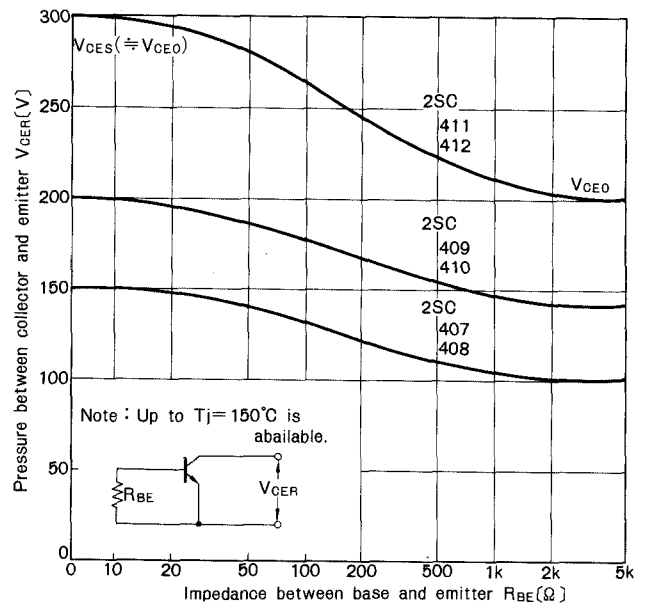
**Heat sink — thermal resistance and allowable collector dissipation**



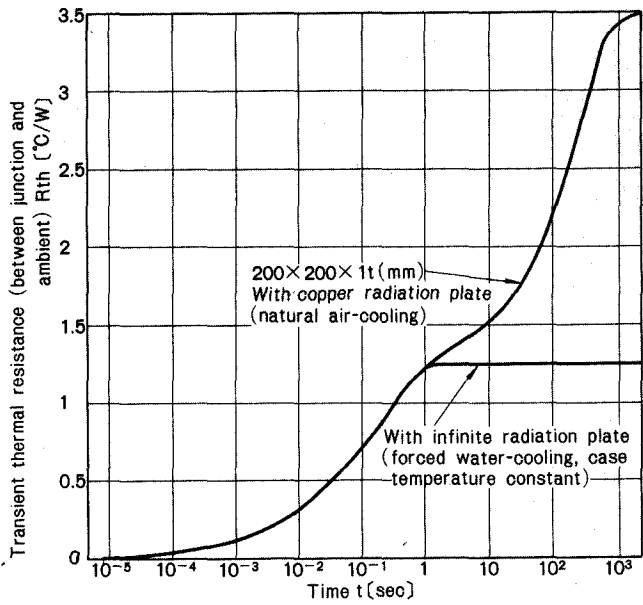
**Heat sink — forced air-cooling and thermal resistance**



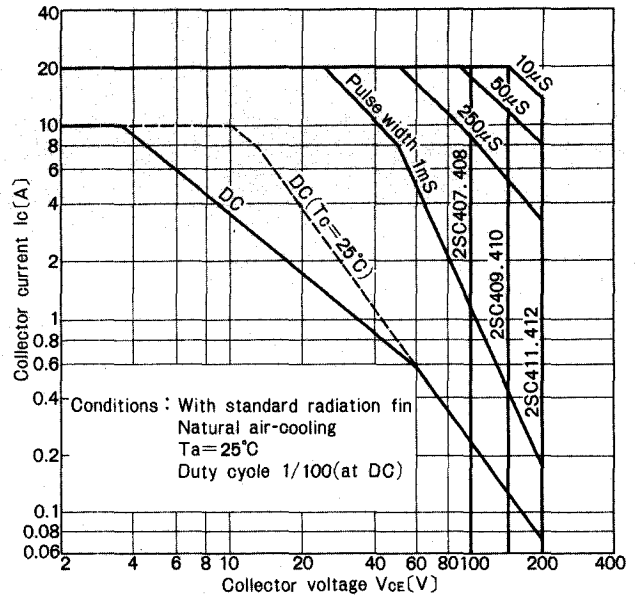
**Signal source impedance — collector and emitter voltage**



### Transient thermal resistance



### Maximum safe operation areas



# POWER TRANSISTOR

	Type	P <sub>c</sub> (W)	I <sub>c</sub> (A)	I <sub>B</sub> (A)	V <sub>CB0</sub> (V)	V <sub>CE0</sub> (V)	V <sub>CEs</sub> (V)	h <sub>FE</sub> (STD)	f <sub>oe</sub> (kHz)	T <sub>j</sub> (°C)	Dimensions	
Germanium transistor	2SB205	80	-20	-3	-80	-	-60	40	2.5	85	Fig.26 (For low-frequency power amplification)	
	2SB206											
	2SB207											
	2SB208											
	2SB207A											
	2SB208A											
	2SB211											
	2SB212											
	2SB213											
	2SB214											
Silicon transistor	2SD206	150	10	4	50	30	-	20	18	150	Fig.27	
	2SD207											
	2SD208											
	2SC407											
	2SC408											
	2SC409											
	2SC410											
	2SC411											
	2SC412											
	2SC431											
High voltage silicon transistor	2SC1466	30	3	1	450	360(sus)	-	16	fr 10	150	Fig.29	
	2SC1467											
	2SC1468	100	100	4	450	360(sus)	-	16	fr 10	150	Fig.27	
												2SC1469
												2SC1470
												2SC1471
	Darlington silicon transistor	2SD384	30	7	0.5	80	80(sus)	-	5000	20	150	Fig.29
		2SD385										

Unit : mm

